Keysight Technologies

EXG X-Series Signal Generators N5171B Analog & N5172B Vector

9 kHz to 1, 3, or 6 GHz

Data Sheet





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Optimized for manufacturing

On the path to faster throughput and greater uptime, the costeffective EXG X-Series signal generators are optimized for manufacturing test. With analog and vector models, the EXG provides the signals you'll need for basic parametric testing of components and functional verification of receivers. Get "just enough" test at the right price with the EXG.

Definitions and Conditions

Specifications represent warranted performance of a calibrated instrument that has been stored for a minimum of 2 hours within the operating temperature range of 0 to 55 °C, unless otherwise stated, and after a 45 minute warm-up period. The specifications include measurement uncertainty. Data represented in this document are specifications unless otherwise noted.

Typical (typ) describes additional product performance information that is not covered by the product warranty. It is performance beyond specifications that 80 percent of the units exhibit with a 90 percent confidence level at room temperature (approximately 25 °C). Typical performance does not include measurement uncertainty.

Nominal (nom) values indicate the expect mean or average performance, or an attribute whose performance is by design, such as the 50 ohm connector. This data is not warranted and is measured at room temperature (approximately 25 °C).

Measured (meas) describes an attribute measured during the design phase for purposes of communicating expected performance, such as amplitude drift vs. time. This data is not warranted and is measured at room temperature (approximately 25 °C).

Frequency Specifications

Option 501 (N5171B only)	9 kHz to 1 GHz	
Option 503	9 kHz (5 MHz IQ mode) to 3 GHz	
Option 506	9 kHz (5 MHz IQ mode) to 6 GHz	
0.001 Hz		
Adjustable in nominal 0.1 ° incre	ments	
Band	Frequency range	N
1	9 kHz to < 5 MHz	Digital synthesis
1	5 to < 250 MHz	1
2	250 to < 375 MHz	0.25
3	375 to < 750 MHz	0.5
4	750 to < 1500 MHz	1
5	1500 to < 3000.001 MHz	2
6	3000.001 to 6000 MHz	4
Standard	Option UNZ ⁴	Option UNZ, typical
≤ 5 ms, typical	≤ 1.15 ms	≤ 950 µs
≤ 5 ms, typical	≤ 900 µs	≤ 800 µs
y)		
≤ 5 ms, typical	≤ 1.15 ms	≤ 1.05 ms
≤ 5 ms, typical	≤ 900 µs	≤ 800 µs
	Option 503 Option 506 0.001 Hz Adjustable in nominal 0.1 ° incres Band 1 1 2 3 4 5 6 Standard ≤ 5 ms, typical ≤ 5 ms, typical y) ≤ 5 ms, typical	Option 503 9 kHz (5 MHz IQ mode) to 3 GHz Option 506 9 kHz (5 MHz IQ mode) to 6 GHz 0.001 Hz Adjustable in nominal 0.1 ° increments Band Frequency range 1 9 kHz to < 5 MHz

- 1. N is a factor used to help define certain specifications within the document.
- 2. Time from receipt of SCPI command or trigger signal to within 0.1 ppm of final frequency or within 100 Hz, whichever is greater, and amplitude settled to within 0.2 dB from 20 to 30 °C. When switching into or out of band 6 amplitude settling time is within 0.3 dB. Implies simultaneous frequency and amplitude switching.
- 3. With internal channel corrections on, the frequency switching speed is < 1.3 ms, measured for list mode and SCPI mode cached frequency points. For the initial frequency point in SCPI mode the time is < 3.3 ms, measured. The instrument will automatically cache the most recently used 1024 frequencies.

 There is no speed degradation for amplitude-only changes
- There is no speed degradation for amplitude-only changes.

 4. Specifications apply when status register updates are off. For export control purposes CW switching speed to within 0.05% of final frequency is 190 µs (measured).

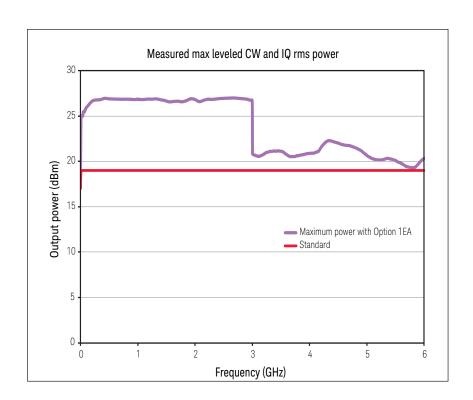
Frequency reference				
Accuracy	 ± (time since last adjustment x aging rate) ± temperature effects ± line voltage effects ± calibration accuracy 			
Internal time base reference oscillator aging rate ¹	≤ ± 5 ppm/10 yrs, < ± 1 ppm/yr			
Initial achievable calibration accuracy	± 4 x 10 ⁻⁸ or ± 40 ppb			
Adjustment resolution	< 1 x 10 ⁻¹⁰			
Temperature effects	± 1 ppm (0 to 55 °C), nominal			
Line voltage effects	± 0.1 ppm, nominal; 5% to –10%, nominal			
Reference output				
Frequency	10 MHz			
Amplitude	≥ +4 dBm, nominal into 50 Ω load			
External reference input				
Input frequency, standard	10 MHz			
Input frequency, Option 1ER	1 to 50 MHz (in multiples of 0.1 Hz)			
Stability	Follows the stability of external reference input signal			
Lock range	± 1 ppm			
Amplitude	> -3.0 to 20 dBm, nominal			
Impedance	50 Ω, nominal			
Waveform	Sine or square			
Sweep modes (frequency and amplitude)				
Operating modes	Step sweep (equally spaced frequency and amplitude or logarithmically spaced frequency steps) List sweep (arbitrary list of frequency and amplitude steps) Simultaneously sweep waveforms with N5172B; see Baseband Generator section for more detail			
Sweep range	Within instrument frequency range			
Dwell time	100 μs to 100 s			
Number of points	2 to 65535 (step sweep) 1 to 3201 (list sweep)			
Step change	Linear or logarithmic			
Triggering	Free run, trigger key, external, timer, bus (GPIB, LAN, USB)			

^{1.} Not verified by Keysight N7800A TME Calibration and Adjustments Software. Daily aging rate may be verified as a supplementary chargeable service, on request.

Amplitude Specifications

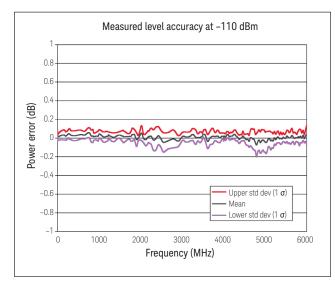
Output parameters		
Settable range	+30 to -144 dBm	
Resolution	0.01 dB	
Step attenuator	0 to 130 dB in 5 dB st	eps electronic type
Connector	Type N 50 Ω, nominal	
Max output power ¹ () = typic	cal	
Frequency	Standard	Option 1EA
9 kHz to 10 MHz	+13 dBm	+17 dBm (+18 dBm)
> 10 MHz to 3 GHz	+18 dBm	+21 dBm (+26 dBm)
> 3 to 6 GHz	+16 dBm	+18 dBm (+19 dBm)

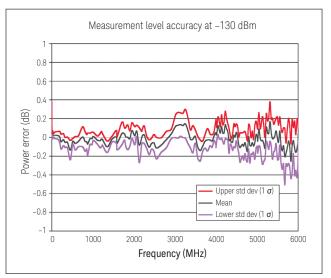
^{1.} Quoted specifications between 20 °C and 30 °C. Maximum output power typically decreases by 0.01 dB/°C for temperatures outside this range.

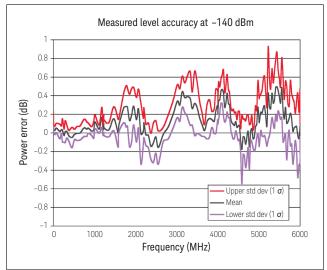


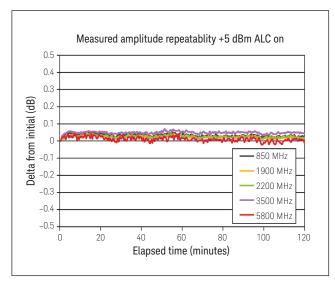
Absolute level accuracy in CW mode	1 (ALC on) ()= typical		
Range	Max power to -60 dBm	< -60 to -110 dBm	< -110 to -127 dBm
9 to 100 kHz	(± 0.6)	(± 0.9)	
100 kHz to 5 MHz	± 0.8 dB (± 0.3)	± 0.9 dB (± 0.3)	
> 5 MHz to 3 GHz	± 0.6 dB (± 0.3)	± 0.8 dB (± 0.3)	(± 0.5)
> 3 to 6 GHz	± 0.6 dB (± 0.3)	± 1.1 dB (± 0.3)	(± 0.6)
Absolute level accuracy in CW mode	(ALC off, power search run, relative	to ALC on)	
9 kHz to 6 GHz	± 0.15 dB, typical		
Absolute level accuracy in digital I/Q	mode (N5172B only)		
(ALC on, relative to CW, W-CDMA 1	DPCH configuration < +10 dBm)		
5 MHz to 6 GHz	± 0.25 dB, (0.05 dB)		

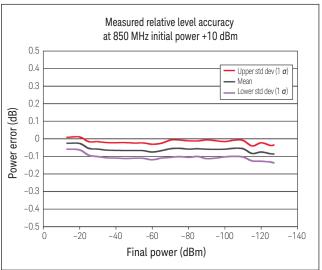
1. Quoted specifications between 20 °C and 30 °C. For temperatures outside this range, absolute level accuracy degrades by 0.01 dB/°C. Output power may drift up to 0.10 dB < 3 GHz and 0.15 dB > 3 GHz per g/kg change in absolute humidity (nom).





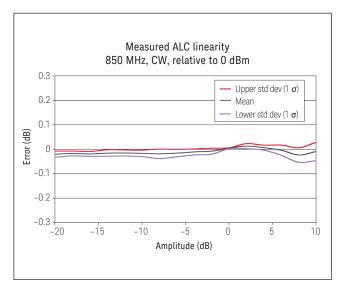


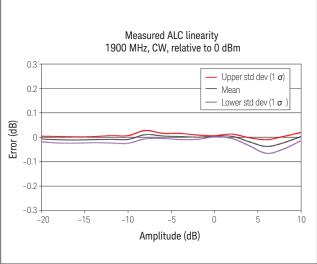




Repeatability measures the ability of the instrument to return to a given power setting after a random excursion to any other frequency and power setting. It should not be confused with absolute level accuracy.

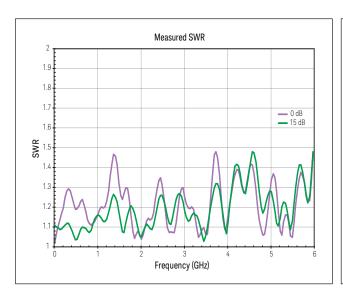
Relative level accuracy measures the accuracy of a step change from any power level to any other power level. This is useful for large changes (such as 5 dB steps).

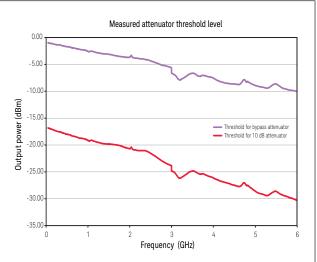




SWR (measured CW mod	e) ¹			
Frequency	Attenuator state			
	Bypass	0 to 10 dB	15 dB or more	
≤ 1.0 GHz	< 1.3:1	< 1.35:1	< 1.2:1	
> 1.0 to 2 GHz	< 1.55:1	< 1:5:1	< 1.3:1	
> 2 to 3 GHz	< 1.8:1	< 1.5:1	< 1.45:1	
> 3 to 4 GHz	< 1.5:1	< 1.6:1	< 1.7:1	
> 4 to 6 GHz	< 1.9:1	< 1.6:1	< 1.6:1	

1. SWR < 1.60:1 below 30 kHz.



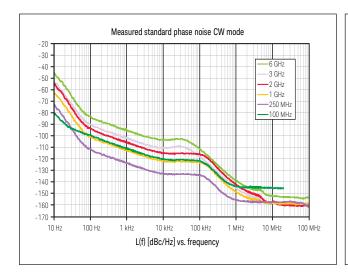


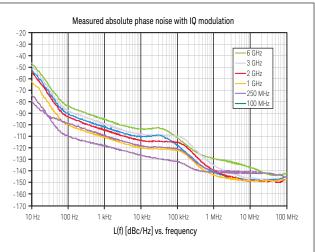
Maximum reverse power, nominal				
< 1 GHz	50 W			
> 1 to 2 GHz	25 W			
> 2 to 6 GHz	20 W			
Max DC voltage	50 VDC			
Trip level	2 W			
Amplitude switching speed 1	Standard	Option UNZ	Option UNZ, typical	
CW mode				
SCPI mode	≤ 5 ms, typical	≤ 750 µs	≤ 650 µs	
Power search SCPI mode	< 12 ms, measured			
List/step sweep mode	≤ 5 ms, typical	≤ 500 µs	≤ 300 µs	
Digital modulation on (N5172B only)				
SCPI mode	≤ 5 ms, typical	≤ 1.15 ms	≤ 950 µs	
Power search SCPI mode	< 12 ms, measured			
List/step sweep mode	≤ 5 ms, typical	≤ 900 µs	≤ 400 µs	
Alternate power level control (N517)	2B only)			
Switching time	20 μs within ± 1 dB, measure	ed		
(via waveform markers)				
Functional power range	-15 dBm to -144 dBm, mea	sured		
User flatness correction				
Number of points	3201			
Number of tables	Dependent on available free memory in instrument; 10,000 maximum			
Entry modes	USB/LAN direct power meter control, LAN to GPIB and USB to GPIB, remote bus and manual USB/GPIB power			
	meter control			
Sweep modes				
	See Frequency Specification	is section for more detail		

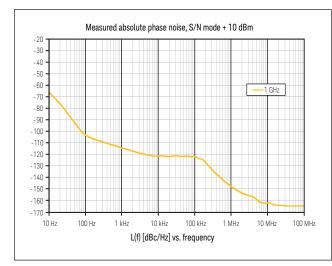
^{1.} Time from receipt of SCPI command or trigger signal to amplitude settled within 0.2 dB. Switching speed specifications apply when status register updates are off.

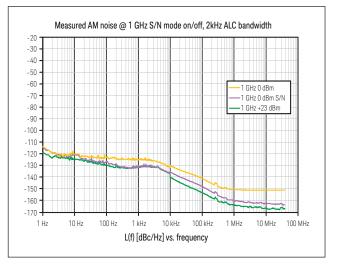
Spectral Purity Specifications

Absolute SSB phase noise (dBc/Hz, CW at 20 kHz offset, typical)		
5 MHz to < 250 MHz	-119	
250 MHz	-133	
500 MHz	-128	
1 GHz	-122	
2 GHz	-115	
3 GHz	-110	
4 GHz	-109	
6 GHz	-103	









5 MHz to 6 GHz	< N x 2 Hz (measured) (see N value	< N x 2 Hz (measured) (see N value in frequency band table)		
Residual AM (CW mode, 0.3 to	3 kHz BW, rms, +5 dBm)			
100 kHz to 3 GHz	< 0.01% (measured)			
Harmonics (CW mode)				
Range	Standard < +4 dBm	Option 1EA < +12 dBm		
9 kHz to 3 GHz	< -35 dBc	< -30 dBc		
> 3 to 4 GHz	< –35 dBc, typical	< -35 dBc, typical		
> 4 to 6 GHz	< –53 dBc, typical	< -40 dBc, typical		
Nonharmonics (CW mode)				
Range	> 10 KHz offset			
	Standard (dBc)			
9 kHz to < 5 MHz	-65, nominal			
5 to < 250 MHz	- 75			
250 to < 750 MHz	- 75			
750 MHz to < 1.5 GHz	-72			
1.5 to < 3.0 GHz	-66			
3 to 6 GHz	-60			

Subharmonics (CW mode)				
9 kHz to 1.5 GHz	None			
> 1.5 to 3 GHz	-77 dBc			
> 3 to 6 GHz	-74 dBc			
Jitter ¹				
Carrier frequency	SONET/SDH data rate	rms jitter BW	μUI rms, measured	Seconds, typical
155 MHz	155 MB/s	100 Hz to 1.5 MHz	140	0.9 ps
622 MHz	622 MB/s	1 KHz to 5 MHz	67	0.11 ps
2.488 GHz	2488 MB/s	5 kHz to 20 MHz	271	0.11 ps
Phase coherence (Option 012)				
LO input frequency range	250 MHz to 6 GHz, nomir	nal		
LO input power range	0 to +12 dBm, nominal			
LO output frequency range	250 MHz to 6 GHz, nomir	nal		
LO output power range	0 to +12 dBm, nominal			

^{1.} Calculated from phase noise performance in CW mode at +10 dBm. For other frequencies, data rates, or bandwidths, please consult your sales representative.

Analog Modulation Specifications

Frequency bands			
Band #	Frequency range	N	
1	9 kHz to < 5 MHz	1 (digital synthesis)	
1	5 to < 250 MHz	1	
2	250 to < 375 MHz	0.25	
3	375 to < 750 MHz	0.5	
4	750 to < 1500 MHz	1	
5	1500 to < 3000.001 MHz	2	
6	3000.001 to 6000 MHz	4	
Frequency modulation (Option UNT) (See N value above)		
Max deviation	N × 10 MHz, nominal ³		
Resolution	0.025% of deviation or 1 Hz, whichever is g	reater, nominal	
Deviation accuracy	< ± 2% + 20 Hz (1 kHz rate, deviation is N x	50 kHz)	
Modulation frequency response	1 dB bandwidth	DC/5 Hz to 3 MHz, nominal	
@ 100 KHz rate	3 dB bandwidth	DC/1 Hz to 7 MHz, nominal	
Carrier frequency accuracy	$\langle \pm 0.2\%$ of set deviation + $(N \times 1 \text{ Hz})^{1}$		
Relative to CW in DCFM	< ± 0.06% of set deviation + (N × 1 Hz), typic	cal ²	
Distortion	< 0.4% [1 kHz rate, deviation is N x 50 kHz]		
FM using external inputs 1 or 2	Sensitivity	+1 V peak for indicated deviation, nominal	
	Input impedance	50 Ω/600 Ω/1 M Ω, nominal	
	Paths	FM path 1 and FM path 2 are summed internally for composite modulation	
Phase modulation (Option UNT) (See	N value above)		
Maximum deviation	Normal bandwidth	N × 5 radians, nominal	
	High-bandwidth mode	N × 0.5 radians, nominal	
Frequency response	Normal bandwidth (3 dB)	DC to 1 MHz, nominal	
	High-bandwidth mode (3 dB)	DC to 4 MHz, nominal	
Resolution	0.1% of deviation		
Deviation accuracy	< + 0.5% + 0.01 rad, typical [1 kHz rate, nor	mal bandwidth mode]	
Distortion	< 0.2% (typ) [1 kHz rate, deviation normal ba	andwidth mode]	
ΦM using external inputs 1 or 2	Sensitivity	+1 V peak for indicated deviation, nominal	
	Input impedance	50 Ω or 600 Ω or 1 M Ω , nominal	
	Paths	ΦM path 1 and ΦM path 2 are summed internally for composite modulation	

Specification valid for temperature changes of less than ± 5 °C since last DCFM calibration.
 Typical performance immediately after a DCFM calibration.
 Digital synthesis band FM deviation is 5 MHz.

AM depth type	Linear or exponential						
Maximum depth	100%						
Depth resolution	0.1% of dept	0.1% of depth (nom)					
AM depth error	f < 5 MHz		< 1.5% of set	ting + 1% (typ 0.5%	of setting + 1%)		
@1 KHz rate and < 80% depth	5 MHz ≤ f ≤ 1	2 GHz	< 3% of setti	ng + 1 %			
	2 < f < 3 GHz		< 5% of setti	ng + 1% (typical 3%	of setting + 1%)		
Total harmonic distortion	F < 5 MHz		30% depth	< 0.25%, typ	ical		
@ 1 KHz rate	F < 3 IVITZ		80% depth	< 0.5%, typic	al		
	5 MHz ≤ f < 1 (2 to 3 GHz i		30% depth	< 2%			
			80% depth	< 2%			
Frequency response	30% depth,	3 dB BW	DC/10 Hz to	50 KHz			
Frequency response wideband AM (N5172B only)	Rates ALC o	ALC off/on: DC/800 Hz to 80 MHz, nominal					
AM inputs using external inputs	Sensitivity +1 V peak for indicated depth (Over-range can be 200% or 2.2 V			6 or 2.2 V peak)			
or 2	Input impedance 50Ω or 600Ω or $1M \Omega$, Damage level: $\pm 5 V$ max						
	Paths		AM path 1 an	AM path 1 and AM path 2 are summed internally for composite			
Wideband AM inputs	Sensitivity		0.25 V = 100°	% (I input + 0.5 V o	ffset)		
(N5172B only)	Input imped	ance	50 Ω, nomina	50 Ω, nominal (I input)			
Simultaneous and composite modu	ılation ²						
Simultaneous modulation	phase modul	lation cannot be co ation source; for ex	ombined and two mod	ulation types canno I/Q generator, AM,	multaneously enabled of the simultaneously gereand FM can run concur	nerated using the	
Composite modulation			of two modulation pat ation of internal or ext		ed internally for compo	site modulation;	
	AM	FM	Phase	Pulse	Internal I/Q ²	External I/Q ²	
AM	+	+	+	+	+	+	
FM	+	+	_	+	+	+	
Phase	+	_	+	+	+	+	
Pulse	+	+	+	-	+	+	
Internal I/Q ²	+	+	+	+	*	+	
External I/Q ²	+	+	+	+	+	_	

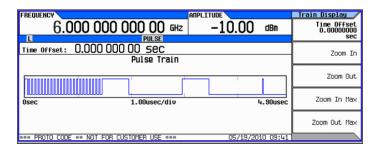
AM specifications apply 6 dB below maximum specified power from 20 to 30 °C.
 I/Q modulation available on N5172B.

(Option UNT required for FM, AM, and phase mo	dulation inputs; Option UNW required for pulse modulation inputs)	
EXT1	AM, FM, PM	
EXT2	AM, FM, PM	
PULSE	Pulse (50 Ω only)	
I	Wideband AM (50 Ω only, N5172B only)	
Input impedance	50Ω , $1M\Omega$, 600Ω , DC and AC coupled	
Standard internal analog modulation source		
(Single sine wave generator for use with AM, FM	II, phase modulation requires Option UNT or 303)	
Waveform	Sine, square, triangle, positive ramp, negative ramp	
Rate range	0.1 Hz to 2 MHz (tunable to 3 MHz)	
Resolution	0.1 Hz	
Frequency accuracy	Same as RF reference source, nominal	
LF audio output	0 to 5 V peak into 50 Ω, –5 V to 5 V offset, nominal	
Multifunction generator (Option 303)		
The multifunction generator option (Option 303) using the composite modulation features in AM, F	consists of seven waveform generators that can be set independently with up to five simultaneously FM/PM, and LF out	
Waveform		
Function generator 1	Sine, triangle, square, positive ramp, negative ramp, pulse	
Function generator 2	Sine, triangle, square, positive ramp, negative ramp, pulse	
Dual function generator	Sine, triangle, square, positive ramp, negative ramp, phase offset, and amplitude ratio for Tone relative to Tone 1	
Swept function generator	Sine, triangle, square, positive ramp, negative ramp Trigger: free run, trigger key, bus, external, internal, timer trigger	
Noise generator 1	Uniform, Gaussian	
Noise generator 2	Uniform, Gaussian	
DC	Only for LF output –5 V to +5 V, nominal	
Frequency parameters		
Sine wave	0.1 Hz to 10 MHz, nominal	
Triangle, square, ramp, pulse	0.1 Hz to 1 MHz, nominal	
Noise bandwidth	10 MHz, nominal	
Resolution	0.1 Hz	
Frequency accuracy	Same as RF reference source, nominal	
Narrow pulse modulation (Option UNW) 1 () = typ	ical	
On/off ratio	(> 80 dB)	
Rise/fall times (Tr, Tf)	< 10 ns; (7 ns)	
Minimum pulse width ALC on/off	≥ 2 us/≥ 20 ns	
Repetition frequency ALC on/off	10 Hz to 500 kHz/DC to 10 MHz	
Level accuracy (relative to CW) ALC on/off ²	< ± 1.0 dB (± 0.5) dB/(< ± 0.5) dB	
Width compression (RF width relative to video out	(< 5 ns)	

^{1.} Pulse specifications apply to frequencies > 100 MHz and power set to > -3 dBm. Operable down to 9 kHz. 2. With power search on.

Video feed-through¹ ≤ 3 GHz/> 3 GHz	(< 50 mV/< 5 mV)
External video delay (ext input to video)	30 ns, nominal
RF delay (video to RF output)	20 ns, nominal
Pulse overshoot	(< 15%)
Input level	+1 Vpeak = RF on into 50 Ω , nominal
T _d video delay (variable) T _w video pulse width (variable) T _p pulse period (variable) T _m RF delay T _{rf} RF pulse width T _f RF pulse fall time T _r RF pulse rise time V _{or} pulse overshoot V _f Video feedthrough	Sync Output Video 50% Output Tp Tp Tr Vor 10% Tr Tr Tr Tr Tr

Internal pulse generator (included with O	ption UNW)			
Modes	Free-run, square, tri	Free-run, square, triggered, adjustable doublet, trigger doublet, gated, and external pulse		
Square wave rate	0.1 Hz to 10 MHz, 0.	0.1 Hz to 10 MHz, 0.1 Hz resolution, nominal		
Pulse period	30 ns to 42 seconds	, nominal		
Pulse width	20 ns to pulse period	d –10 ns, nominal		
Resolution	10 ns			
Adjustable trigger delay	(-pulse period + 10 r	ns) to (pulse width –10 ns)		
Settable delay	Free run	–3.99 to 3.97 μs		
	Triggered	0 to 40 s		
Resolution (delay, width, period)	10 ns, nominal			
Pulse doublets	1st pulse delay	(Relative to sync out) 0 to 42 s - pulse width - 10 ns		
	1st pulse width	500 ns to 42 s - delay - 10 ns		
	2nd pulse delay	0 to 42 s - (Delay 1 + Width 2) - 10 ns		
	2nd pulse width	20 ns to 42 s – (Delay 1 + Delay 2) – 10 ns		
Pulse train generator Option 320 (require	s Option UNW)			
Number of pulse patterns	2047	2047		
On/off time range	20 ns to 42 sec			



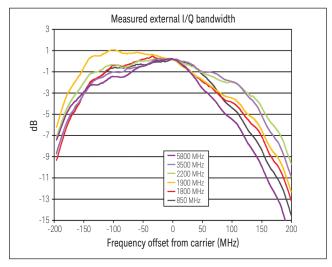
^{1.} Video feed through applies to power levels < +10 dBm.

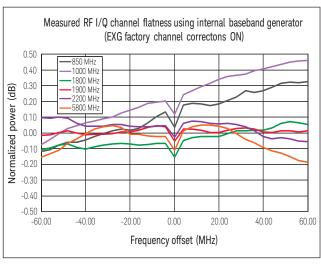
Vector Modulation Specifications

N5172B only

I/Q modulator external inputs 1			
Bandwidth	Baseband (I or Q)	Up to 100 MHz baseband, nominal	
	RF (I+Q)	Up to 200 MHz RF, nominal	
I or Q offset	± 100 mV (200 uV resolution	on)	
I/Q gain balance	± 4 dB (0.001 dB resolution	n)	
I/Q attenuation	0 to 50 dB (0.01 dB resolut	tion)	
Quadrature angle adjustment	± 200 units		
Full scale input drive (I+Q)	$0.5V$ into 50Ω , nominal		
Internal I/Q baseband generator adju	stments 1,2 (Options 653 and 655)		
I/Q offset	± 20%	(0.025% dB resolution)	
I/Q gain	± 1 dB	(0.001 dB resolution)	
Quadrature angle adjustment	± 10 °	(0.01 degrees resolution)	
I/Q phase	± 360.00 °	(0.01 degrees resolution)	
I/Q skew	± 500 ns	(1 picosecond resolution)	
I/Q delay	± 250 ns (1 picosecond resolution)		
External I/Q outputs ¹			
Impedance	50Ω , nominal per output		
	100 Ω, nominal differential	$100~\Omega$, nominal differential output	
Туре	Single-ended or differentia	Single-ended or differential (Option 1EL)	
Maximum voltage per output	1 V peak-to-peak or 0.5 V peak; into 50 Ω (200 uV resolution)		
Bandwidth (I, Q)	Baseband (I or Q)	60 MHz, nominal (Option 653 and 655)	
	RF (I+Q)	120 MHz, nominal (Option 653 and 655)	
Amplitude flatness	± 0.2 dB measured with channel corrections optimized for I/Q output		
Phase flatness	± 2.5 degrees measured with channel corrections optimized for I/Q output		
Common mode I/Q offset	\pm 1.5 V into 50 Ω (200 uV resolution)		
Differential mode I or Q offset	\pm 50 mV into 50 Ω (200 uV resolution)		

- 1. I/Q adjustments represent user interface nominal parameter ranges and not specifications.
- 2. Internal I/Q adjustments apply to RF out and I/Q outputs simultaneously.





Internal real-time complex digital I/Q filters (included with Option 653)

Factory channel correction (256 taps)

Corrects the linear phase and amplitude response of the baseband I/Q and RF outputs of the signal generator using factory calibration arrays (default mode is off).

RF amplitude flatness (120 MHz)	± 0.2 dB measured	
RF phase flatness (120 MHz)	± 2 degrees measured	

User channel correction (256 taps)

Automated routine uses USB power sensor to correct for linear phase and amplitude response of DUT (equalizer). See User Guide for more details.

Equalization filter (256 tans)	
Max RF phase flatness correction	± 20 degrees
Max RF amplitude flatness correction	± 15 dB

Equalization filter (256 taps)

User can download and apply inverse or custom phase and amplitude response coefficients from tools such as MATLAB, 89600 VSA, or SystemVue to correct for linear errors of DUT/system. See User Guide for more details.

Baseband generator (Options 653 and 65	5)	
Channels	2 [I and Q]	
Resolution	16 bits [1/65,536]	
Sample rate	Option 653	100 Sa/s to 75 MSa/s
	Option 653 and 655	100 Sa/s to 150 MSa/s
RF (I+Q) bandwidth	Option 653	60 MHz, nominal
	Option 653 and 655	120 MHz, nominal
Interpolated DAC rate	800 MHz (waveforms only need OSR = 1.	25)
Frequency offset range	± 60 MHz	
Digital sweep modes	· · · · · · · · · · · · · · · · · · ·	can have independent waveforms (N5172B) along with user see the Amplitude and Frequency Specifications sections for more
Waveform switching speed ¹	0001 1-	≤ 5 ms, measured (standard)
	SCPI mode	≤ 1.2 ms, measured (Option UNZ)
	List/stan surray and	≤ 5 ms, measured (standard)
	List/step sweep mode	≤ 900 us, measured (Option UNZ)
Waveform transfer rates	FTP LAN to internal SSD	10.7 MB/sec or 2.67 Msa/sec
(measured, no markers, unencrypted)	Internal SSD to FTP LAN	7.7 MB/sec 1.92 Msa/sec
	FTP LAN to BBG	8.2 MB/sec or 2.05 Msa/sec
	FTP LAN to BBG encrypted	4 MB/sec or 1 Msa/sec
	USB to BBG	19 MB/sec or 4.75 Msa/sec
	BBG to USB	1.2 MB/sec or 300 Ksa/sec
	Internal SSD to BBG	48 MB/sec or 12 Msa/sec
	BBG to internal SSD	1.2 MB/sec or 300 Ksa/sec
	SD card to BBG (Option 006)	
	BBG to SD card (Option 006)	845 KB/sec or 211 Ksa/sec

^{1.} SCPI mode switching speed applies when waveforms are pre-loaded in list sweep and sample rate ≥ 10 MSa/s.

Arbitrary waveform memory		32 Msa (standard)		
	Maximum playback capacity	256 Msa (Option 021)		
		512 Msa (Option 022)		
	Maximum storage	3 GBytes/800 Msa (standard)		
	capacity including	30 GBytes/7.5 Gsa (Option 009)		
	markers	8 GBytes / 2 Gsa (Or	otion 006)	
Waveform segments		60 samples to 32 Ms	sa (standard)	
	Segment length	60 samples to 256 N	Asa (Option 021)	
		60 samples to 512 Msa (Option 022)		
	Minimum memory allocation per segment	256 samples		
	Maximum number of segments	8192		
Waveform sequences	Maximum number of sequences	> 2000 depending o	n non-volatile memory usage	
	Maximum number of	32,000 (standard)		
	segments/sequence	4 million (Option 02)	1 or 022)	
	Maximum number of repetitions	65,535		
Triggers	Types		Continuous, single, gated, segment advance	
	Source		Trigger key, external, bus (GPIB, LAN, USB)	
		Continuous	Free run, trigger and run, reset and run	
	Modes	Single	No retrigger, buffered trigger, restart on trigger	
		Gated	Negative polarity or positive polarity	
		Segment advance	Single or continuous	
	External coarse delay tir	me	5 ns to 40 s	
	External coarse delay resolution		5 ns	
	Trigger latency (Single trigger only)		356 ns + 1 sample clock period, nominal	
	Trigger accuracy (Single trigger only)		± 2.5 ns, nominal	
	Single trigger - restart on trigger mode will initiate a FIFO clear. Therefore, the latency includes re-filling the buffer. The latency is 8 µs + (1406 x sample period) ± 1 sample clock period, nominal			
Multi-baseband generator synchroniza-	Fan out		1 master and up to 15 slaves	
tion mode (multiple sources)	Trigger repeatability		< 1 ns, nominal	
	Trigger accuracy		Same as normal mode	
	Trigger latency		Same as normal mode	
	Fine trigger delay range		See Internal I/Q Baseband section	
	Fine trigger delay resolu	tion	See Internal I/Q Baseband section	
	I/Q phase adjustment range		See Internal I/Q Baseband section	
Markers	Markers are defined in a segment during the wa		aveform generation process, or from the front panel; a marker d functions, and alternate amplitude; see Users Guide for more	
	Marker polarity		Negative, positive	
	Number of markers		4	
	RF blanking/burst on/off ratio		> 80 dB	
	Alternate amplitude control switching s		See amplitude section	

Real-time modulation FIR filter:	Nyquist, root-Nyquist, WCDMA, EDGE, Gaussian, rectangular, APCO 25 C4FM, IS-95, User FIR		
		olaying waveforms with OSR=1. Helps reduce waveform size for long	
	simulation times. Option 660 not requ	urea).	
Real-time baseband generator (Option (
Real-time baseband generator required	Cellular real-time applications	LTE-FDD, LTE-TDD, HSPA+/W-CDMA, GSM/EDGE, cdma2000®	
for real-time Signal Studio	Real-time navigation	GPS, GLONASS, Galileo	
applications ¹	Real-time video applications	DVB-T/T2/H/S/S2/C/J.83 Annex A/C, ISDB-T/	
	Note: Option 660 is not required for rea	l-time custom modulation (Option 431)	
	Memory: Shares memory with Options	653 and 655	
	Triggering: Same as Options 653 and	655	
	Markers: 3 markers available, all other features are same as Options 653 and 655		
Digital baseband inputs/outputs (Optio	n 003/004)		
Options 003 and 004 activate the rear pa	anel digital I/Q bus and enables connec	tivity to the N5102A digital signal interface module. In output mode	
(003), you can deliver realistic complex-r	modulated signals such as LTE, GPS, W	AN, custom pulses and many others directly to your digital devices and	
	, , , , ,	ut to the signal generator's baseband system, providing a quick and easy	
· · · · · · · · · · · · · · · · · · ·	·	ating modes, the interface module adapts to your device with the logic	
type, data format, clock features, and sig	naling you require.		
Data (requires N5102A)			
Digital data format	User-selectable: 2's complement or binary offset, I/Q (I, I-bar, Q, Q-bar) or digital IF output (real, imaginary)		
Data port	Dual 16-bit data buses support parallel, parallel I/Q interleaved, parallel QI interleaved, or serial port		
	configuration		
N5102A connectors (breakout boards)	144-pin Tyco Z-Dok+ connects to break-out boards (included with N5102A) that interface with the following connector types: 68-pin SCSI, 38-pin dual AMP Mictor, 100-pin dual Samtec, 20-pin dual 0.1 inch headers,		
	40-pin dual 0.1 inch headers		
Logic types	Single-ended: LVTTL, 1.5V CMOS, 1.8V CMOS, 2.5V CMOS, 3.3.V CMOS		
	Differential: LVDS		
Data output resampling	EXG baseband output is resampled to the arbitrary clock rate set by the user via real-time curve-fit		

 $^{1. \}quad \text{See www.keysight.com/find/signal studio for more information.} \\$

calculations.

Clock (requires N5102A)			
Clock input	User selectable: internal clock, device under test clock, or external clock (via SMA or breakout board)		
	N5102A SMA Ext Clock In connector: 50 Ω, 0 dBm nominal, 1 to 400 MHz		
Clock output	User selectable: via breakout board or SMA Clock Out connector		
	N5102A SMA Clock Out connector: 2 Vpp into load > 5 K Ω from 1 to 100 kHz, 400 mVpp into 50 Ω 100 kHz to 400 MHz		
Sample rate (limited by EXG sample rate)	User-selectable in parallel mode u users guide for more details).	p to a maximum 150 MHz, but limited by other user settings (see N5102A	
	User-selectable in serial mode, the	e maximum rate is 400 MHz/word size.	
Bit rate (limited by EXG sample rate)	Parallel Up to 150 MHz x word size 2 parallel buses available	e (1.6 Gbps LVDS, CMOS and LVTTL) per parallel bus,	
	Serial Up to 400 MHz per serial lin lines available	e (400 Mbps LVDS) or 150 MHz per serial line (150 Mbps (CMOS/LVTTL) 32	
Clocks per sample	In parallel output mode, the data s	cample can be held for 1, 2 or 4 clock cycles	
Clock to data skew	Coarse adjustment in 90° steps from	om 0 to 270°; fine-adjustment in increments of 100 ps up to 5 ns	
Clock polarity	Clock signals may be inverted		
Frequency reference input	1 to 100 MHz BNC, 50 Ω , 3 dBm \pm	6 dB,	
Power supply (included on N5102A)	Output: 5 V, 4 A DC		
AWGN (Option 403)			
Туре	Real-time, continuously calculated, and played using DSP		
Modes of operation	Standalone or digitally added to si	gnal played by arbitrary waveform or real-time baseband generator	
Bandwidth	With Option 653	1 Hz to 60 MHz	
	With Option 653 and 655	1 Hz to 120 MHz	
Crest factor	15 dB		
Randomness	90 bit pseudo-random generation, repetition period 313 x 10 ⁹ years		
Carrier-to-noise ratio	± 100 dB when added to signal		
Carrier-to-noise ratio formats	C/N, Eb/No		
Carrier-to-noise ratio error	Magnitude error ≤ 0.2 dB at baseb	and I/Q outputs	
Custom modulation Arb Mode (Option	431)		
Modulation	PSK	BPSK, QPSK, OQPSK, π/4DQPSK, gray coded and unbalanced QPSK, 8PSK, 16PSK, D8PSK	
	QAM	4, 16, 32, 64, 128, 256, 1024 (and 89600 VSA mappings)	
	FSK	Selectable: 2, 4, 8, 16, C4FM	
	MSK	0 to 100°	
	ASK	0 to 100%	
Multicarrier	Number of carriers	Up to 100 (limited by a max bandwidth of 120 MHz depending on symbol rate and modulation type)	
	Frequency offset (per carrier)	Up to -60 to +60 MHz	
	Power offset (per carrier)	0 dB to -40 dB	
Symbol rate	50 sps to 75 Msps		
Filter types	Nyquist, root-Nyquist, Gaussian, rectangular, APCO 25 C4FM, user		
Quick setup modes		PSK, Bluetooth®, CDPD, DECT, EDGE, GSM, NADC, PDC, PHS, PWT, TETRA	
Data	Random only		

Modulation	PSK				
		16PSK, D8PSK, IS95 QPSK, IS	S95 OQPSK, EDGE, HDQPSK, SOQPSK		
	QAM	4, 16, 32, 64, 128, 256, 1024 (and 89600 VSA mappings)			
		Selectable	2,4,8, 16 level symmetric, C4FM, HCPM		
	FSK	User-defined	Custom map of up to 16 deviation levels		
		Max deviation	20 MHz		
	MSK	0 to 100°			
	ASK	0 to 100%			
	DVB-S2 APSK		16APSK 2/3, 16APSK 3/4, 16APSK 4/5, 16APSK 5/6, 16APSK 8/9, 16APSK 9/10, 32APSK 3/4, 32APSK 4/5, 32APSK 5/6, 32APSK 8/9, 32APSK 9/10		
	Custom I/Q	Custom map of 1024 unique v	values		
requency offset	Up to -60 MHz to +60 MHz	Z			
Symbol rate	Internal generated data	1 sps to 75 Msps and max of	10 bits per symbol (Option 653 + 655)		
	External serial data	1 sps to [(50 Mbits/sec)/(#bits	s/symbol)]		
ilter types	Selectable	Nyquist, root-Nyquist, Gaussi DL), IS-95, WCDMA, EDGE (w	an, rectangular, APCO 25 (phase 1 and 2 UL and ride and HSR)		
		IS-95 w/EQ, IS-95 Mod, IS-95 Mod w/EQ, HDQPSK, APCO25 HCPM, SOQPSK-TG			
	Custom FIR	16-bit resolution, up to 64 symbols long, automatically resampled to 1024 coefficients (max) > 32 to 64 symbol filter: symbol rate ≤ 12.5 MHz > 16 to 32 symbol filter: symbol rate ≤ 25 MHz Internal filters switch to 16 tap when symbol rate is between 25 and 75 MHz			
Quick setup modes	APCO 25 with (C4FM, CQP PHS, PWT, WorldSpace, Iri		vetooth, CDPD, DECT, EDGE, GSM, NADC, PDC,		
		16APSK 2/3, 16APSK 3/4, 16APSK 4/5, 16APSK 5/6, 16APSK 8/9, 16APSK 9/10, 32APSK 3/4, 32APSK 4/5, 32APSK 5/6, 32APSK 8/9, 32APSK 9/10, SOQPSK			
Trigger delay	Range		0 to 1,048,575 bits		
	Resolution		1 bit		
Data types	Internally generated	Pseudo-random patterns	PN9, PN11, PN15, PN20, PN23		
	internatty generated	Repeating sequence	Any 4-bit sequence		
	D' L LL DAMEDDAN	п	32 Mb (standard)		
	Direct-pattern RAM [PRAM Note: Used for custom TDI	-	512 Mb (Option 021)		
	INOTE. USER IN CUSTOM ID	win vi non-standard frammy	1024 Mb (Option 022)		
			32 MB (standard)		
	User file		256 MB (Option 021)		
			512 MB (Option 022)		
	Externally streamed data	Туре	Serial data		
	(via AUX I/O)	Inputs/outputs ¹	Data, symbol sync, bit clock		
nternal burst shape	Rise/fall time range		Up to 30 bits		
varies with bit rate)	Rise/fall delay range		-15 to +15 bits		

^{1.} Bit clock and symbol sync inputs will be available in future firmware release.

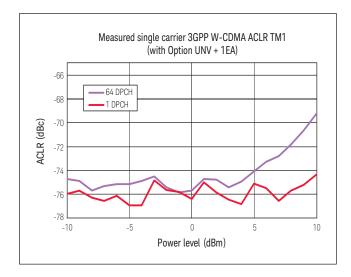
Multitone and two-tone (Option 430)			
Number of tones	2 to 512, with selectable of	2 to 512, with selectable on/off state per tone	
Frequency spacing	100 Hz to 120 MHz (with 0	Option 653 and 655)	
Phase (per tone)	Fixed or random		
Real-time phase noise impairments (O	ents (Option 432)		
Close-in phase noise characteristics	-20 dB per decade		
Far-out phase noise characteristics	-20 dB per decade		
Mid-frequency characteristics	Start frequency (f1)	Offset settable from 0 to 77 MHz	
	Stop frequency (f2)	Offset settable from 0 to 77 MHz	
Phase noise amplitude level (L(f))	User selected; max degradation dependent on f2		

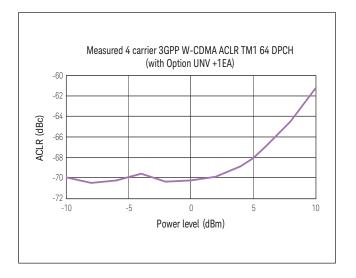


3GPP W-CDMA dist	ortion performance 1,2	!						
			Standard		Option UN	I	Option UN\ with Option	
Power level			≤ 2 dBm²		≤ 2 dBm²		≤ 5 dBm ²	
Offset	Configuration	Frequency	Spec	Тур	Spec	Тур	Spec	Тур
Adjacent (5 MHz)	- 1 DPCH. 1 carrier	1800 to 2200 MHz	- 69 dBc	-73 dBc	-71 dBc	-75 dBc	-71 dBc	-75 dBc
Alternate (10 MHz)	- I DPCH, I carrier		-70 dBc	-75 dBc	-72 dBc	-77 dBc	-71 dBc	-77 dBc
Adjacent (5 MHz)	Test model 1 with	1000 to 2200 MHz	-68 dBc	-70 dBc	-71 dBc	-73 dBc	-71 dBc	-72 dBc
Alternate (10 MHz)	64 DPCH, 1 carrier	1800 to 2200 MHz		-73 dBc	-72 dBc	-76 dBc	-71 dBc	-76 dBc
Adjacent (5 MHz)	Test model 1 with	1800 to 2200 MHz	-63 dBc	-65 dBc	-65 dBc	-67 dBc	-64 dBc	-66 dBc
Alternate (10 MHz)	64 DPCH, 4 carrier		-64 dBc	-66 dBc	-66 dBc	-68 dBc	-66 dBc	-68 dBc

^{1.} ACPR specifications apply when the instrument is maintained within \pm 20 to 30 °C.

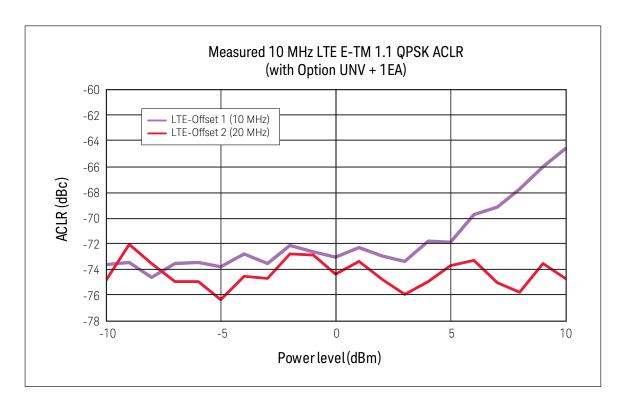
This is rms power. Convert from rms to peak envelope power (PEP) with the following equation: PEP = rms power + crest factor (for example, 3GPP test model 1 with 64 DPCH has a crest factor 11.5 dB, therefore at +5 dBm rms, the PEP = 5 dBm + 11.5 dB = +16.5 dBm PEP).





3GPP LTE-FDD distortion performance ¹								
			Standard		Option UN	V	Option UN with Option	
Power level			≤ 2 dBm²		≤ 2 dBm²		≤ 5 dBm²	
Offset	Configuration	Frequency	Spec	Тур	Spec	Тур	Spec	Тур
Adjacent (10 MHz) ³	10 MHz E-TM 1.1	1000 to 2200 MHz	-64 dBc	-66 dBc	-67 dBc	-69 dBc	-64 dBc	-67 dBc
Alternate (20 MHz) ³	QPSK	1800 to 2200 MHz	-66 dBc	-68 dBc	-69 dBc	-71 dBc	-69 dBc	-71 dBc

- 1. ACPR specifications apply when the instrument is maintained within \pm 20 to 30 °C.
- 2. This is rms power. Convert from rms to peak envelope power with the following equation: PEP = rms power + crest factor (for example, 3GPP test model 1 with 64 DPCH has a crest factor 11.5 dB, therefore at +5 dBm rms, the PEP = 5 dBm + 11.5 dB = +16.5 dBm PEP).
- 3. ACPR measurement configuration: reference channel integration BW: 9.015 MHz, offset channel integration bandwidth: 9.015 MHz.



spectrum (ORFS)					
		GSM		EDGE	
		< +7 dBm		< +7 dBm	
Configuration	Frequency ¹	Standard, typical	Option UNV, typical	Standard, typical	Option UNV, typical
		-34 dBc	-36 dBc	-37 dBc	-38 dBc
1	000+- 000 MII-	-69 dBc	-70 dBc	-69 dBc	-70 dBc
,		-81 dBc	-82 dBc	-80 dBc	-81 dBc
bursted	1800 to 1900 WITIZ	-82 dBc	-83 dBc	-82 dBc	-83 dBc
		-84 dBc	-85 dBc	-83 dBc	-84 dBc
tortion performance	, typical				
		Standard	Option UNV	Option UNV + 1EA	
		≤ 2 dBm	≤ 2 dBm	≤ 5 dBm	
Configuration	Frequency (1)	Typical	Typical	Typical	
0 1 16 1		-78 dBc	-79 dBc	-77 dBc	
	800 to 900 MHz	-86 dBc	-87 dBc	-87 dBc	
UIIK		-91 dBc	-93 dBc	-93 dBc	
AX™ distortion perfo	ormance, measured				
Offset ³	Configuration 4	Frequency	Standard, measured	UNV, measured	
10 MHz	QPSK	2.5 and 3.5 GHz	-65 dBc	-68 dBc	
10 MHz	QPSK	3.5 GHz	-62 dBc	-65 dBc	
	Configuration 1 normal timeslot, bursted Configuration 9 channel forward link AXTM distortion performance Offset 3 10 MHz	Configuration Frequency 1 1 normal timeslot, 800 to 900 MHz bursted 1800 to 1900 MHz 1800 to 1900 MHz Atortion performance, typical Configuration Frequency (1) 9 channel forward link 800 to 900 MHz AXTM distortion performance, measured Offset 3 Configuration 4 10 MHz QPSK	GSM < +7 dBm Configuration Frequency¹ Standard, typical -34 dBc -69 dBc -69 dBc -81 dBc -82 dBc -82 dBc -84 dBc -84 dBc -84 dBc -84 dBc -84 dBc -84 dBc -84 dBc -84 dBc -84 dBc -84 dBc -84 dBc -84 dBc -84 dBc -84 dBc -84 dBc -84 dBc -	Configuration Frequency Standard, typical Option UNV, typical	Configuration Frequency Standard, typical Option UNV, typical Standard, typical Option UNV, typical Standard, typical Option UNV, typical Standard, typical -34 dBc -36 dBc -37 dBc -69 dBc -70 dBc -69 dBc -81 dBc -82 dBc -83 dBc -82 dBc -83 dBc -82 dBc -83 dBc -82 dBc -83 dBc -83 dBc -82 dBc -83 dBc -73 dBc -73 dBc -73 dBc -73 dBc -73 dBc -83 dBc

Performance evaluated at bottom, middle, and top of bands shown.

This is rms power. Convert from rms to peak envelope power (PEP) with the following equation: PEP = rms power + crest factor (for example: 3GPP test model 1 with 64 DPCH has a crest factor > 11 dB, therefore at +5 dBm rms the PEP = 5 dBm + 11 dB = +16 dBm PEP).

Measurement configuration: reference channel integration BW: 9.5 MHz, offset channel integration BW: 9 MHz, channel offset: 10 MHz.

802.16e WiMAX signal configuration—bandwidth: 10 MHz, FFT: 1024, frame length: 5 ms, guard period: 1/8, symbol rolloff: 5%, content: 30 symbols of

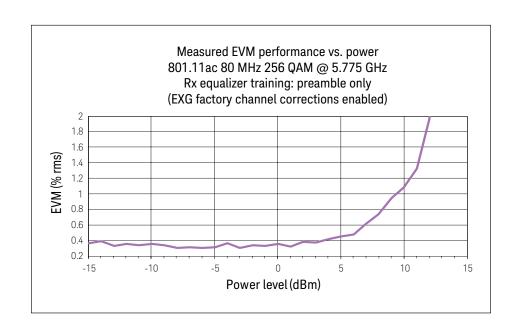
PN9 data.

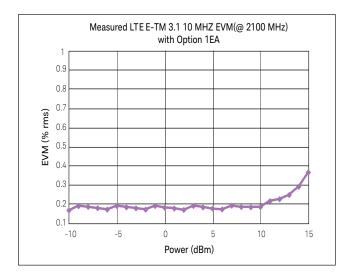
EVM performance	data 1, 2										
Format	GSM		EDGE		cdma200	0/IS95A	W-CDMA		LTE FDD	3	
Modulation type	GMSK (burs	sted)	3pi/8 8PSł	(bursted)	QPSK	QPSK		QPSK		64 QAM	
Modulation rate	270.833 ks	OS	70.833 ksp	OS	1.2288 Mo	ps	3.84 Mcps	S	10 MHz E	3W	
Channel configuration	1 timeslot		1 timeslot		Pilot chan	nel	1 DPCH		E-TM 3.1		
Frequency ⁴	800 to 900 1800 to 190		800 to 900 1800 to 19	–		800 to 900 MHz 1800 to 1900 MHz		1800 to 2200 MHz		2200 MHz	
EVM power level	≤ 7 dBm		≤ 7 dBm		≤ 7 dBm		≤7 dBm		≤ 7 dBm		
EVM power level with Option 1EA	≤ 13 dBm		≤ 13 dBm		≤ 13 dBm		≤ 13 dBm		≤ 13 dBm	1	
EVM/global phase error	Spec	Туре	Spec	Туре	Spec	Туре	Spec	Туре	Measure	d	
	ms 0.8 °	0.2 °	1.2%	0.75%	1.3%	0.8%	1.2%	0.8%		0.2%	
Format	802.11a/g	802.11ac ⁵	QPSK				16 QAM				
Modulation type	64 QAM	256 QAM	QPSK				16 QAM				
Modulation rate	54 Mbps	80 MHz BW	4 Msps (ro	ot-Nyquist filte	$\alpha = 0.25$						
Frequency ⁴	2400 to 2484 MHz		- ≤ 3 GHz		≤ 6 GHz		≤ 3 GHz		≤ 6 GHz		
	5150 to 5825 MHz	5.775 GHz									
EVM power level	≤ -5 dBm	≤ -5 dBm	≤ 4 dBm		≤ 4 dBm		≤ 4 dBm		≤ 4 dBm		
EVM power level with Option 1EA	≤ 2 dBm	≤2 dBm	≤ 10 dBm		≤ 10 dBm		≤ 10 dBm		≤ 10 dBm	1	
EVM	Measured	Measured	Spec	Туре	Spec	Туре	Spec	Туре	Spec	Туре	
	0.3%	0.4%	1.2%	0.8%	1.9%	1.1%	1.1%	0.65%	1.5%	0.9%	
		•	•		•				•		

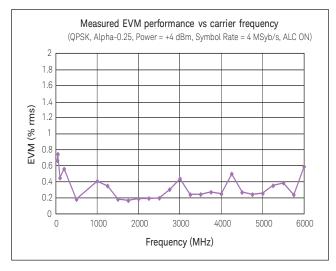
EVM specifications apply for the default ARB file setup conditions with the default ARB files supplied with the instrument. EVM specifications apply after execution of I/Q calibration when the instrument is maintained within ± 5 °C of the calibration temperature. LTE FDD E-TM 3.1,10 MHz, 64 QAM PDSCH, full resource block. Measured EVM after DC calibration. 2.

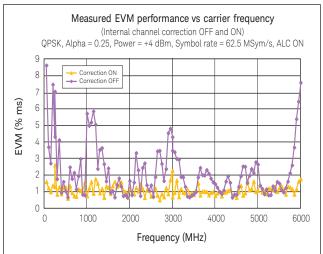
Performance evaluated at bottom, middle, and top of bands shown.

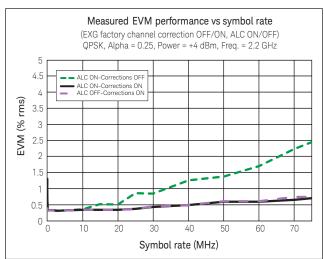
WLAN 802.11ac 80 MHz, 256 QAM, MCS 8, 7 symbols, no filtering. Channel corrections enabled. Rx equalizer training: preamble only.











Bit error rate [BER] analyzer (Option UN7)	
Clock rate	100 Hz to 60 MHz (usable to 90 MHz)
Data patterns	PN9, 11, 15, 20, 23
Resolution	10 digits
Bit sequence length	100 bits to 4,294 Gbits after synchronization
Other features	Input clock phase adjustment and gate delay Direct measurement triggering Data and reference signal outputs Real-time display Bit count Error-bit-count Bit error rate Pass/fail indication Valid data and clock detection Automatic re-synchronization Special pattern ignore

General Specifications

Remote programming	
Interfaces	GPIB IEEE-488.2, 1987 with listen and talk
	LAN 1000BaseT LAN interface, LXI Class C compliant USB Version 2.0
Control languages	SCPI Version 1997.0
Compatibility languages	Keysight Technologies: N5181A\61A, N 5182A\62A, N5183A, E4438C, E4428C, E442xB, E443xB, E8241A, E8244A, E8251A, E8254A, E8247C, E8257C/D, E8267C/D, 8648 Series, 8656B, E8663B, 8657A/B, 8662A, 8663A
	Aeroflex Inc.: 3410 Series
	Rohde & Schwarz: SMB100A, SMBV100A, SMU200A, SMJ100A, SMATE200A, SMIQ, SML, SMV
Power requirements	
100-120 VAC, 50/60/400 Hz 220-240 VAC, 50/60 Hz 160 W maximum (N5171B) 300 W maximum (N5172B)	
Operating temperature range	
0 to 55 °C	
Storage temperature range	
-40 to 70 °C	

Operating and storage altitude

Up to 15,000 feet

Humidity

Relative humidity - type tested at 95%, +40 °C (non-condensing)

Environmental stress

Samples of this product have been type tested in accordance with the Keysight Environmental Test Manual and verified to be robust against the environmental stresses of storage, transportation and end-use; those stresses include but are not limited to temperature, humidity, shock, vibration, altitude, and power line conditions; test methods are aligned with IEC 60068-2 and levels are similar to MIL-PRF-28800F Class 3

S	af	etv
•		

Complies with European Low Voltage Directive 2006/95/EC

- IEC/EN 61010-1, 2nd Edition	Acoustic noise emission	Geraeuschemission
Canada: CSA C22.2 No. 61010-1	LpA < 70 dB	LpA < 70 dB
- USA: UL std no. 61010-1, 2nd Edition	Operator position	Am Arbeitsplatz
 German Acoustic statement 	Normal position	Normaler Betrieb
	Per ISO 7779	Nach DIN 45635 t.19

EMC

Complies with European EMC Directive 2004/108/EC

- IEC/EN 61326-1 or IEC/EN 61326-2-1	This ISM device complies with Canadian ICES-001;
 CISPR Pub 11 Group 1, class A 	cet appareil ISM est conforme a la norme NMB-001 du Canada
AS/NZS CISPR 11	
- ICES/NMB-001	

Memory

- Memory is shared by instrument states, user data files, sweep list files, waveform sequences, and other files
- 3 GB (30 GB with Option 009) memory available in the N5172B
- Security Option 006 allows storage of up to 8 GB on SD card
- Depending on how the memory is utilized, a maximum of 1000 instrument states can be saved

Security (Option 006)

- Removable 8 GB solid state memory (SD card) from rear panel
- User can force all files to be stored only on external memory card including instrument states, user data files, sweep list files, waveforms, waveform sequences, and other files.
- Memory sanitizing, memory sanitizing on, power on, and display blanking
- Disable USB ports
- Note: Read/write speeds to external memory card will be slower compared to internal solid-state drive (Option 009)

Self-test

Internal diagnostic routines test most modules in a preset condition; for each module, if its node voltages are within acceptable limits, the module passes the test

Weight

N5171B: \leq 13.6 kg (30 lb) net, \leq 28.6 kg (63 lb) shipping N5172B: \leq 15.9 kg (35 lb) net, \leq 30.8 kg (68 lb) shipping

Dimensions

88 mm H x 426 mm W x 489 mm L (length includes rear panel feet)

(3.5 in H x 16.8 in W x 19.2 in L)

Max length (L) including RF connector tip to end of rear panel feet is 508 mm (20 in)

Recommended calibration cycle

36 months

ISO compliant

This instrument is manufactured in an ISO-9001 registered facility in concurrence with Keysight Technologies' commitment to quality.

Inputs and Outputs

Front panel connectors	
RF output	Outputs the RF signal via a precision N type female connector; see output section for reverse power protection information
I and Q inputs	BNC input accepts "in-phase" and "quadrature" input signals for I/Q modulation; nominal input impedance is 50Ω , damage levels are 1 Vrms and 5 Vpeak
USB 2.0	Used with a memory stick for transferring instrument states, licenses and other files into or out of the instrument; also used with U2000, U848X, and U202X Series USB power sensors
Rear panel connectors	
Rear panel inputs and outputs are 3.3 V	CMOS, unless indicated otherwise; CMOS inputs will accept 5 V CMOS, 3 V CMOS, or TTL voltage levels
RF output (Option 1EM)	Outputs the RF signal via a precision N type female connector
I and Q inputs (Option 1EM)	Accepts "in-phase" and "quadrature" input signals for I/Q modulation SMB connector, nominal input impedance is 50 Ω; damage levels are 1 Vrms and 5 Vpeak; Option 1EM units will come with 2 SMB to BNC adapters
I and Q outputs	BNC outputs the analog I/Q modulation signals from the internal baseband generator; nominal output impedance 50 Ω , DC coupled; damage levels \pm 2 V
I bar and Q bar outputs (Option 1EL)	BNC outputs the complement of the I and Q signals for differential applications;

Event 1	This connector outputs the programmable timing signal generated by marker 1 The marker signal can also be routed internally to control the RF blanking and ALC hold functions; this signal is also available on the AUX I/O connector With bit error rate analyzer (Option UN7) this connector is used for data input Damage levels are > +8 V and < -4 V
Pattern trigger	Accepts signal to trigger internal pattern generator to start single pattern output, for use with the internal baseband generators Accepts CMOS signal with minimum pulse width of 10 ns Female BNC Damage levels are > +8 V and < -4 V
BBTRIG 1	For arbitrary and real-time baseband generators I/O such as Markers or trigger inputs With bit error rate analyzer (Option UN7) this connector is used for clock input
BBTRIG 2	For arbitrary and real-time baseband generators I/O such as Markers or trigger inputs With bit error rate analyzer (Option UN7) this connector is used for gate input
Sweep out	Generates output voltage, 0 to +10 V when the signal generator is sweeping; this output can also be programmed to indicate when the source is settled or output pulse video and is TTL and CMOS compatible in this mode; output impedance < 1 Ω , can drive 2 k Ω ; damage levels are \pm 15 V
Ext 1	External AM/FM/PM #1 input; nominal input impedance is 50 $\Omega/600~\Omega/1M~\Omega$, nominal; damage levels are \pm 5 V
Ext 2	External AM/FM/PM #2 input; nominal input impedance is 50 $\Omega/600~\Omega$ /1M Ω , nominal; damage levels are \pm 5 V
LF OUT	0 to 5 V peak into 50 Ω, -5 V to 5 V offset, nominal
Pulse	External pulse modulation input; this input is TTL and CMOS compatible; low logic levels are 0 V and high logic levels are +1 V; nominal input impedance is 50 Ω ; input damage levels are \leq -0.3 V and \geq +5.3 V
Trigger in	Accepts TTL and CMOS level signals for triggering point-to-point in sweep mode; damage levels are ≤ -0.3 V and ≥ +5.3 V
Trigger out	Outputs a TTL and CMOS compatible level signal for use with sweep mode The signal is high at start of dwell, or when waiting for point trigger in manual sweep mode, and low when dwell is over or point trigger is received This output can also be programmed to indicate when the source is settled, pulse synchronization, or pulse video Nominal output impedance $50~\Omega$ Input damage levels are $\leq -0.3~V$ and $\geq +5.3~V$
Reference input	Accepts a 10 MHz reference signal used to frequency lock the internal timebase; Option 1ER adds the capability to lock to a frequency from 1 MHz to 50 MHz; nominal input level -3 to $+20$ dBm, impedance 50 Ω , sine or square waveform
10 MHz out	Outputs the 10 MHz reference signal used by internal timebase; level nominally +3.9 dBm; nominal output impedance 50 Ω; input damage level is +16 dBm
LO in (Option 012)	Accepts a signal from a master signal generator that is used as the LO for EXG vector in order to configure a phase coherent system; nominal input levels between 0 to +12 dBm; nominal input impedance $50~\Omega$
LO out (Option 012)	Outputs a reference signal that can be used in a phase coherent system; nominal output levels between 0 to +12 dBm; nominal output impedance 50 Ω
DAC Clk In (Option 012)	Reserved for future use.
Digital bus I/O	To be used with PXB or N5102A digital signal interface module

Aux I/O	Aux I/O port sends and/or receives auxiliary signaling information: For Option UN7 this connector is used to output reference data, clock, error signals, and more Output markers to an external device from arbitrary waveform or real-time generation application such as: frame markers, pulse-per-second, even-second, and more. Input signals from external DUT to modify characteristics of a signal being generated. Such as: changing output power (power control loop testing), advancing or delaying timing (timing advance loop testing), HARQ ACK/NAK delivery (HARQ process loop testing) or streaming external data, clock and symbol synch for custom modulation. I/O is application specific (CDMA, 3GPP, GNSS, LTE, custom etc). See User Guide or Signal Studio help for more details. Connector type: 36 pin 3M connector (part number N10236-52B2PC). The mating connector is a 3M 10136-3000 wire mount plug or 3M 10136-8000 IDC plug with a 3M 10336 shell. For Option 431 real-time custom modulation the follow pin numbers are assigned: Data input = pin 23 Data clock input = pin 29 Symbol sync input = pin 25 Burst input = pin 35 Data clock output = pin 35 Data clock output = pin 37 Event 1 output = pin 37 Event 1 output = pin 33
USB 2.0	The USB connector provides remote programming functions via SCPI
LAN (1000 BaseT)	The LAN connector provides the same SCPI remote programming functionality as the GPIB connector and is also used to access the internal Web server and FTP server Supports DHCP, sockets SCPI, VXI-11 SCPI, connection monitoring, dynamic hostname services, TCP keep alive LXI class C compliant Trigger response time for the immediate LAN trigger is 0.5 ms (minimum), 4 ms (maximum), 2 ms, typical; delayed/alarm trigger is unknown Trigger output response time is 0.5 ms (minimum), 4 ms (maximum), 2 ms, typical
GPIB	The GPIB connector provides remote programming functionality via SCPI

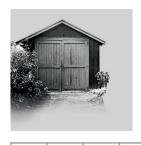
Related Literature

Keysight X-Series Signal Generators

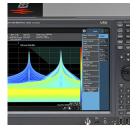
EXG Configuration Guide	5990-9958EN
MXG Data Sheet	5991-0038EN
MXG Configuration Guide	5990-9959EN
X-Series Signal Generator Brochure	5990-9957EN
Signal Studio Software Brochure	5989-6448EN

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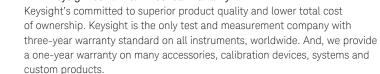
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